

R5007FNX

Nch 500V 7A Power MOSFET

Datasheet

V _{DSS}	500V
R _{DS(on)} (Max.)	1.3Ω
I _D	±7A
P _D	43W

Features

1) Fast reverse recovery time (trr).

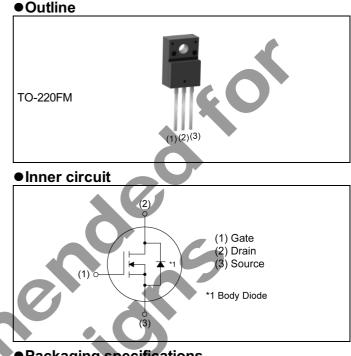
- 2) Low on-resistance.
- 3) Fast switching speed.
- 4) Gate-source voltage (V_{GSS}) guaranteed to

be ±30V.

Application

Switching Power Supply

- 5) Drive circuits can be simple.
- 6) Pb-free lead plating ; RoHS compliant



Packaging specifications

0	G	Packing	Bulk
	0.	Reel size (mm)	-
		Tape width (mm)	-
	Туре	Basic ordering unit (pcs)	500
	Taping code	-	
		Marking	R5007FNX

• Absolute maximum ratings (T_a = 25°C , unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain - Source voltage		V _{DSS}	500	V
	T _C = 25°C	I _D *1	±7	А
Continuous drain current	T _C = 100°C	I _D ^{*1}	±3.4	А
Pulsed drain current	I _{DP} *2	±28	A	
Gate - Source voltage	V _{GSS}	±30	V	
Avalanche current, single pulse	I_{AS}^{*3}	3.5	А	
Avalanche energy, single pulse	E _{AS} *3	3.2	mJ	
Avalanche energy, repetitive	E _{AR} *4	2.6	mJ	
Power dissipation $(T_c = 25^{\circ}C)$	P _D	43	W	
Junction temperature	Tj	150	°C	
Operating junction and storage te	T _{stg}	-55 to +150	°C	
Reverse diode dv/dt	dv/dt	15	V/ns	

•Absolute maximum ratings

Parameter			Symbol Conc		onditions		Values	Unit
Drain - Source voltage slope			dv/dt	V _{DS} = 400V, I _D = 7A T _j = 125°C		50	V/ns	
●Thermal resistance								
Parameter			Syn	nbol	Min.	Values Typ.	Max.	Unit
Thermal resistance, junction - cas	е		R _t	hJC		-	2.85	°C/W
Thermal resistance, junction - aml	pient		R _t	hJA		-	70	°C/W
Soldering temperature, wavesold	ering for 10s		Ts	old	9	-	265	°C
●Electrical characteristics (T _a	= 25°C)		0		5	Values		
Parameter	Symbol	Ċ	Condition	3	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V _{(BR)DS\$}	V _{GS} = 0	V, I _D = 1r	nA	500	-	-	V
Drain - Source avalanche breakdown voltage	V _{(BR)DS}	V _{GS} = 0	V, I _D = 3.	5A	-	580	-	V
Zero gate voltage drain current	IDSS	$V_{DS} = 5$ $T_j = 25^{\circ}$ $T_j = 12^{\circ}$		s = 0V	-	1 -	100 10000	μΑ
Gate - Source leakage current	I _{GSS}	V _{GS} = ±	30V, V _{DS}	= 0V	-	-	±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} = 1	0V, I _D = 1	ImA	2	-	4	V
Static drain - source on - state resistance	R _{DS(on)} *6	$V_{GS} = 1$ T _j = 25 ^o T _j = 12 ^o		3.5A	-	1.0 1.98	1.3	Ω
Gate resistance	R _G	f = 1MH	z, open d	rain	-	7.3	-	Ω

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•Electrical characteristics (T_a = 25°C)

Deremeter	Cumphal	Conditions	Values			L lucit
Parameter Symbol		Conditions	Min.	Тур.	Max.	Unit
Forward Transfer Admittance	Y _{fs} * ⁶	$ Y_{fs} ^{*6}$ $V_{DS} = 10V, I_D = 3.5A$		4.2	_	S
Input capacitance	C _{iss}	V _{GS} = 0V	-	450		
Output capacitance	C _{oss}	V _{DS} = 25V	-	300		pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	20	-	
Effective output capacitance, energy related	C _{o(er)}	V _{GS} = 0V,		22.3	-	
Effective output capacitance, time related	C _{o(tr)}	V _{DS} = 0V to 400V		61.9	-	pF
Turn - on delay time	t _{d(on)} *6	$V_{DD} \simeq 250V, V_{GS} = 10V$	-	13	-	
Rise time	t,*6	I _D = 3.5A		13	-	
Turn - off delay time	t _{d(off)} *6	R _L ≃ 71.5Ω		30	60	ns
Fall time	t _f *6	R _G = 10Ω		20	40	

• Gate charge characteristics ($T_a = 25^{\circ}C$

Parameter Symbol Co	Values	Unit
Parameter Symbol Co	Min. Typ.	Max.
Total gate charge Q_g^{*6} $V_{DD} \simeq 250$	V - 15	-
Gate - Source charge Q_{gs}^{*6} $I_D = 7A$	- 3.5	- nC
Gate - Drain charge Q_{gd}^{*6} $V_{GS} = 10V$	- 6	-
Gate plateau voltage $V_{(plateau)}$ $V_{DD} \simeq 250$	V, I _D = 7A - 6.1	- V

*1 Limited only by maximum temperature allowed.

*2 Pw \leq 10µs, Duty cycle \leq 1%

*3 L \simeq 500µH, V_{DD}=50V, R_G=25 Ω , starting T_j=25°C

*4 L~500µH, V_{DD}=50V, R_G=25 Ω , starting T_j=25°C, f=10kHz

*5 Reference measurement circuits Fig.5-1.

*6 Pulsed

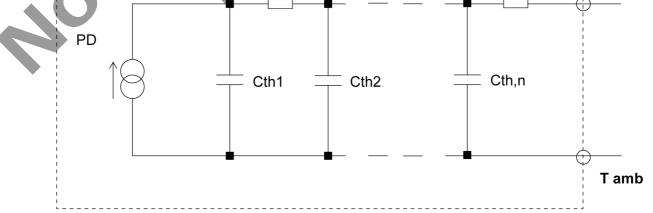


•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Symbol	Conditions	Values			Unit
Symbol	Conditions	Min.	Тур.	Max.	Unit
۱ _S *1	T - 25°0	-	-	7	А
ا _{SP} *2	$T_{\rm C} = 25 {\rm C}$	-	-	28	A
V_{SD}^{*6}	V _{GS} = 0V, I _S = 7A	-	-	1.5	V
t _{rr} *6		-	70	-	ns
Q _{rr} *6	U U		0.20	-	μC
۴ ⁶ ا			5.8	-	А
di _{rr} /dt	T _j = 25°C).	510	-	A/µs
	I _{SP} *2 V _{SD} *6 t _{rr} *6 Q _{rr} *6 I _{rrm} *6	$ \begin{array}{c} I_{S}^{*1} \\ I_{SP}^{*2} \\ \hline V_{SD}^{*6} \\ V_{GS} = 0V, I_{S} = 7A \\ \hline U_{rr}^{*6} \\ \hline I_{rrm}^{*6} \\ \hline I_{rrm}^{*6} \\ \hline \end{array} $	$ \begin{array}{c c} & \text{Min.} \\ \hline I_{S}^{*1} \\ \hline I_{SP}^{*2} \\ \hline V_{SD}^{*6} \\ \hline V_{GS} = 0V, I_{S} = 7A \\ \hline t_{rr}^{*6} \\ \hline I_{S} = 7A \\ \hline di/dt = 100A/\mu s \\ \hline \end{array} $	Symbol Conditions Min. Typ. I_S^{*1} $T_C = 25^{\circ}C$ - - I_{SP}^{*2} $T_C = 25^{\circ}C$ - - V_{SD}^{*6} $V_{GS} = 0V, I_S = 7A$ - - V_{rr}^{*6} $I_S = 7A$ - - I_{rrr}^{*6} $I_S = 7A$ - 0.20 I_{rrrr}^{*6} - 5.8 -	Symbol Conditions Min. Typ. Max. I_S^{*1} $T_C = 25^{\circ}C$ - - 7 I_{SP}^{*2} $T_C = 25^{\circ}C$ - - 28 V_{SD}^{*6} $V_{GS} = 0V, I_S = 7A$ - - 1.5 t_{rr}^{*6} $I_S = 7A$ - 70 - Q_{rr}^{*6} $I_S = 7A$ - 5.8 -

Typical transient thermal characteristics

Symbol	Value	Unit	Symbol	Value	Unit			
R _{th1}	0.327		C _{th1}	0.00167				
R _{th2}	1.12	к/w	C _{th2}	0.0151	Ws/K			
R _{th3}	2.00		C _{th3}	0.391				
	Тј	Rth1	— — _ #	Rth,n T c	ase			







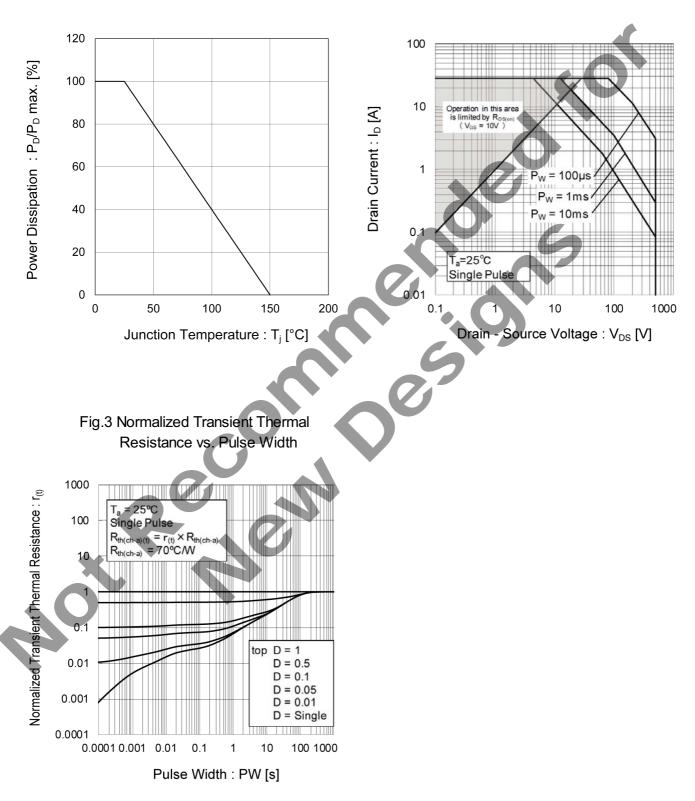


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area



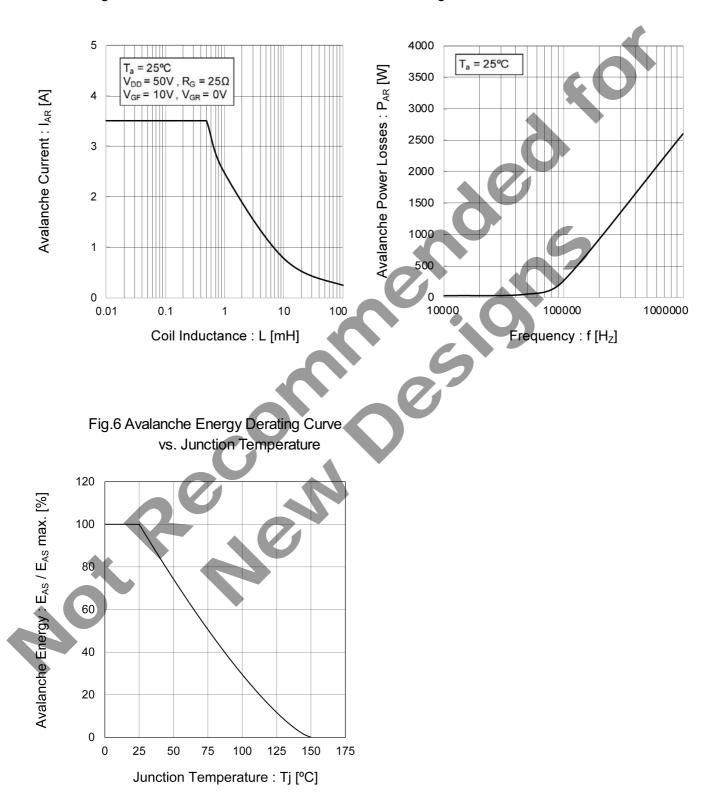
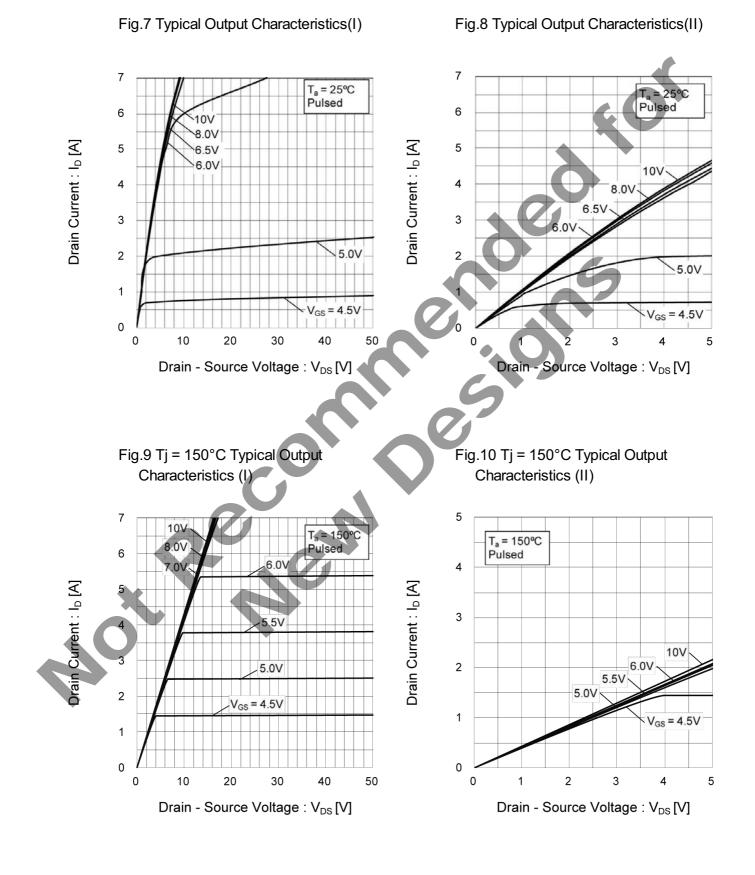


Fig.4 Avalanche Current vs. Inductive Load Fig.5 Avalanche Power Losses







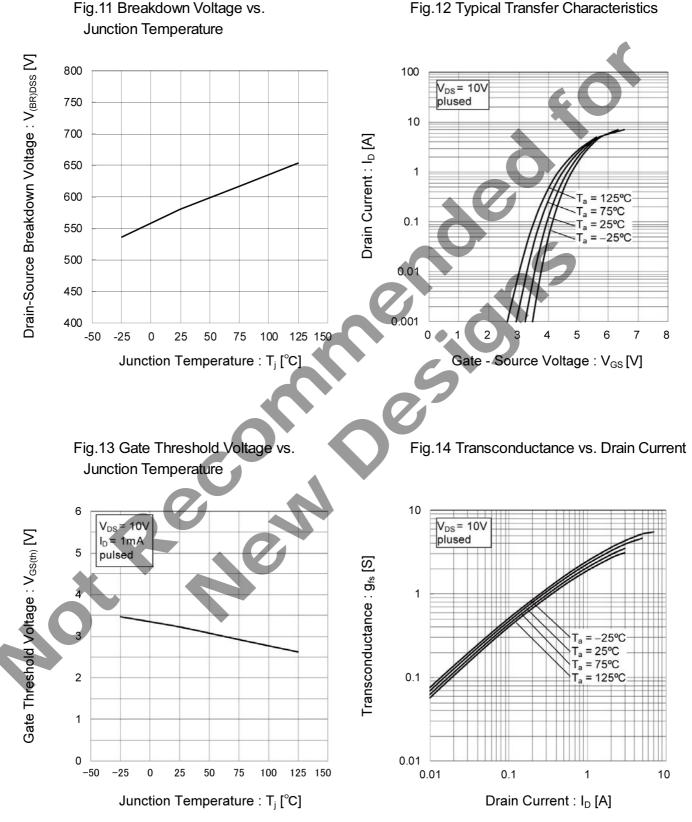
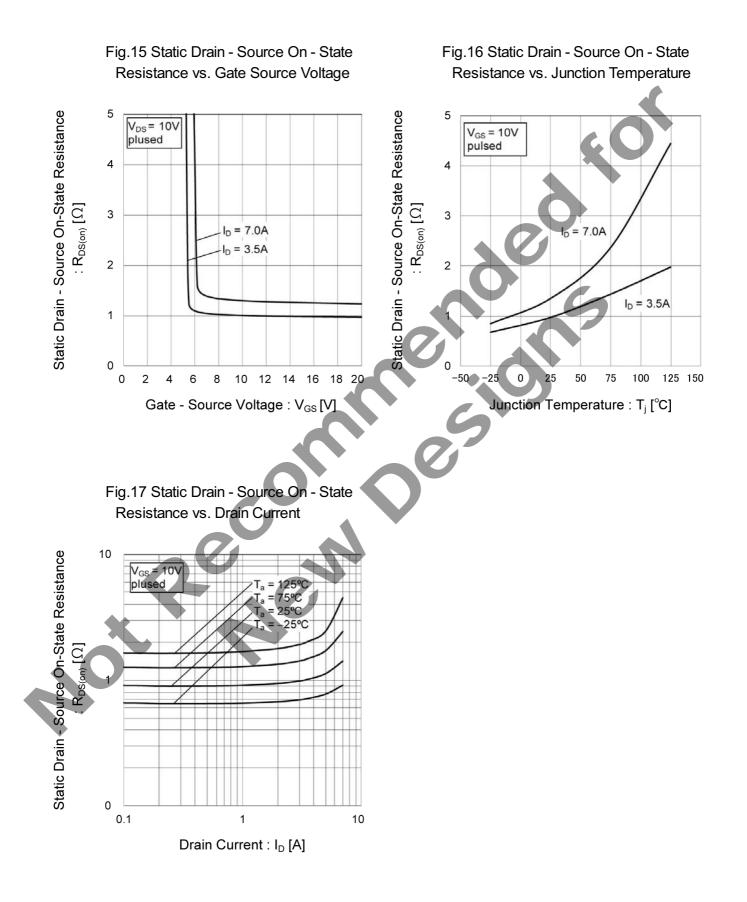
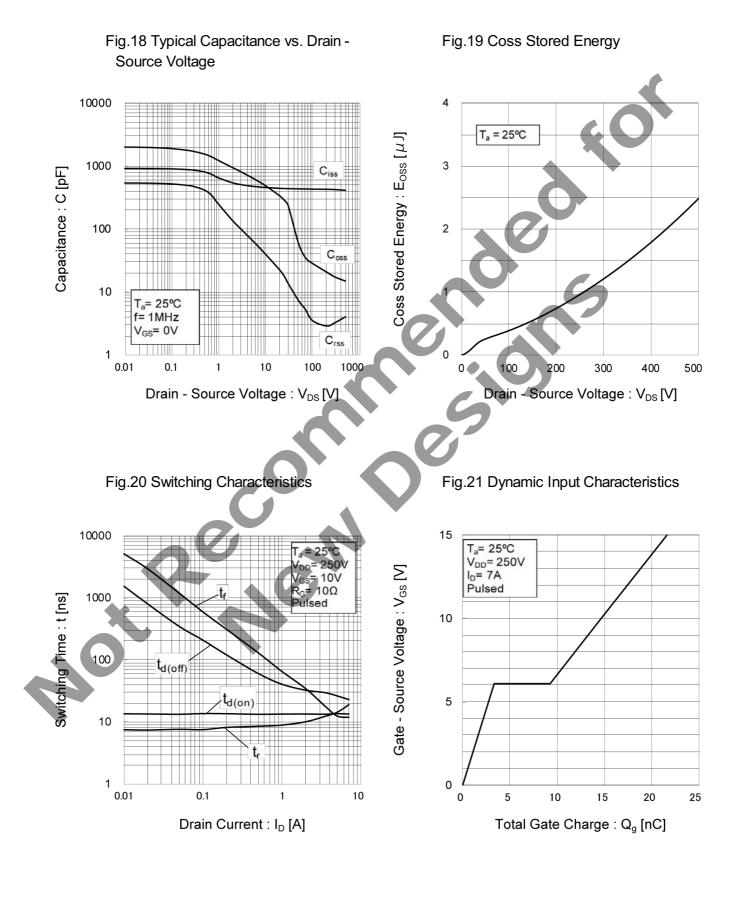


Fig.12 Typical Transfer Characteristics

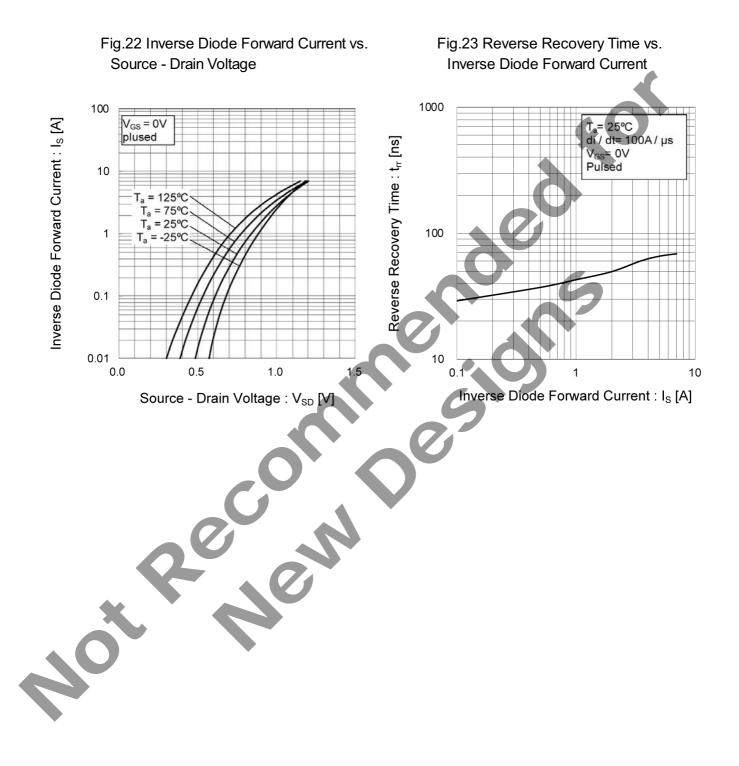








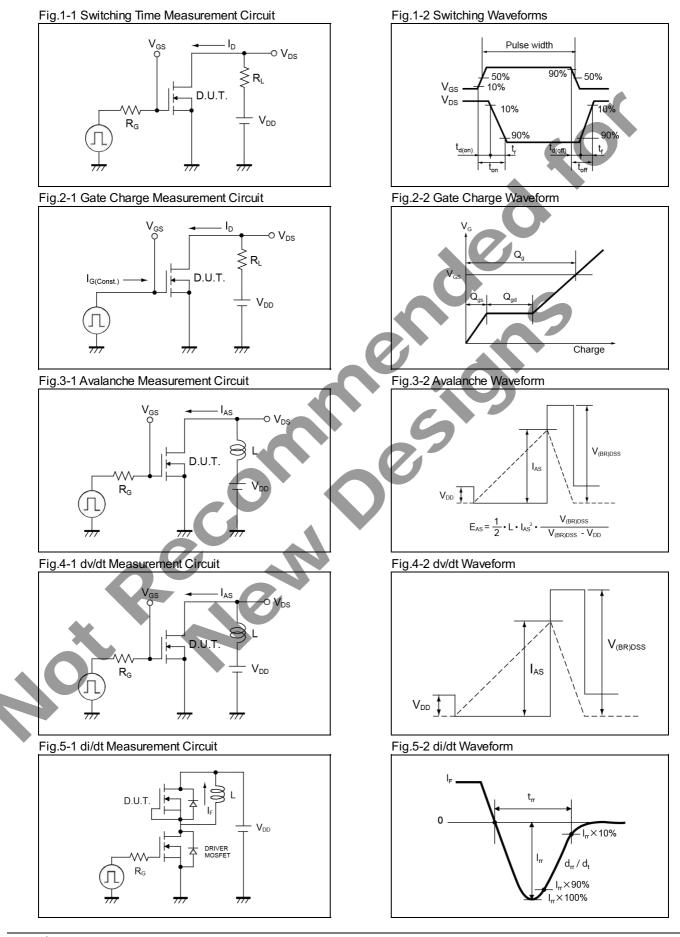








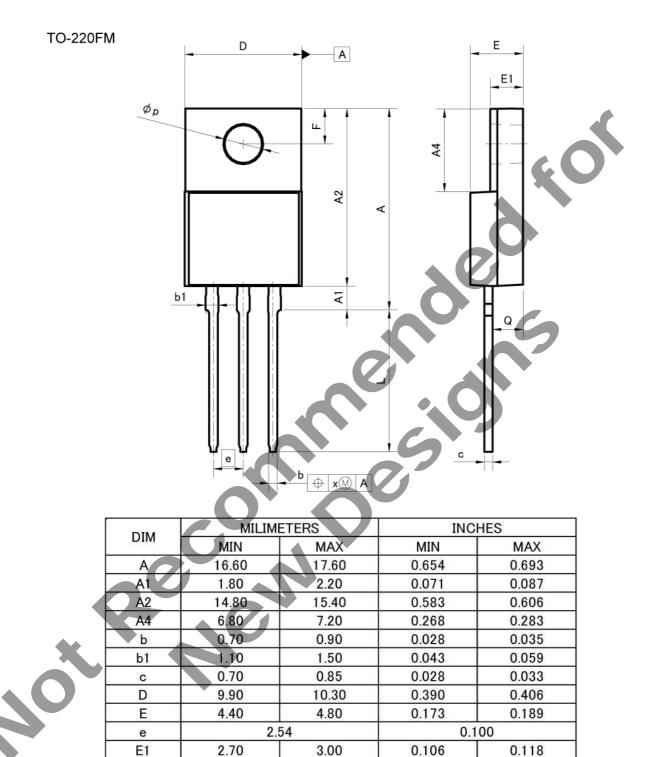
Measurement circuits





20160324 - Rev.002

Dimensions



F

L

p Q

х

2.80

11.50

3.00

2.10

_

Dimension in mm/inches



3.20

12.50

3.40

3.10

0.38



0.126

0.492

0.134

0.122

0.015

0.110

0.453

0.118

0.083

223

Notice

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(Note1) Medical Equipment Classification of the Specific Applications					
	JAPAN	USA	EU	CHINA	

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CLASS II b

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[a] Installation of protection circuits or other protective devices to improve system safety

CLASS III

- [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.

CLASS III

CLASSIV

- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power, exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.

- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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